

INNOPAD ANNOUNCES NEW EXECUTIVE APPOINTMENTS

Company Moves to Strengthen Executive Team With Experienced Technology Leaders

Peabody, MA – June 25, 2010 – innoPad, Inc., a leader in CMP pad technology, today announced the appointment of Stephen Hymes as the company's Vice President of Engineering and Peter Hutchinson as the company's Vice President of Operations. "I am excited to have both Stephen and Peter join our team during this important time for the company," said John Aldeborgh, Chief Executive Officer of innoPad. "Stephen's extensive experience in CMP product and application development, combined with Peter's demonstrated leadership in high-tech manufacturing, will be invaluable to innoPad as we introduce new products and expand our manufacturing infrastructure to meet customer demands."

Mr. Hymes brings over fifteen years of technical leadership experience in advanced semiconductor manufacturing and the CMP process. Most recently as the Vice President of Applications at SemiQuest, Inc., a start-up CMP pad company, Mr. Hymes led the application development effort and was responsible for key account penetration at device manufacturers, industry consortia, and equipment manufacturers. Previously, Mr. Hymes served in technical leadership roles at established leaders in integrated device manufacturing, including AMD and SEMATECH, as well as at associated chemical companies and CMP start-ups. Mr. Hymes received his Bachelors in Engineering from Harvey Mudd College, his Masters in Electrical Engineering from University of Colorado, and his PhD in Material Engineering from Rensselaer Polytechnic Institute.

Mr. Hutchinson brings a proven track record of establishing world class manufacturing systems and techniques in high technology companies. Most recently as the President and Director of Operations for Photodetection Systems, Inc., a company developing Positron Emissions Tomography (PET) Scanners for the Medical Equipment market, Mr. Hutchinson led the establishment of a new manufacturing facility that doubled manufacturing output and the negotiations of a major OEM Supply agreement that would realize revenues of up to \$100MM. Previously, Mr. Hutchinson served in several operations leadership roles in the electronics and medical equipment industry, including as the Chief Operating Officer of Display World, Inc., a movable displays manufacturer, and as the Director of Manufacturing Operations at Analogic Corporation, a publicly-traded signal- and image-processing company. Mr. Hutchinson received his Bachelors in Mechanical Engineering from Northeastern University and has taken MBA courses at New Hampshire College.

The Company also announced that Paul Lefevre, the former Vice President of Engineering, has been appointed to the Company's Technical Advisory Board.

innoPad, Inc. develops and markets polishing pads used in chemical mechanical planarization (CMP), a critical process in semiconductor manufacturing. innoPad's Micro-channel™ technology platform represents a new approach to pad design, providing unprecedented levels of design flexibility and control. With Micro-channel™ technology, innoPad delivers drop-in solutions today and a customizable next generation CMP platform for tomorrow. innoPad is based in Peabody, Massachusetts, and can be found on the web at www.innopad.com.